

Jan 2018 Rev. 1.0.1

GENERAL DESCRIPTION

The XR3160 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards. Full operation requires only four external charge pump capacitors.

The RS-485/RS-232 pin selects RS-485 mode when high and RS-232 mode when low. The HALF/FULL pin configures the RS-485 modes as either half or full duplex.

The high speed drivers operate up to 20Mbps in RS-485/422 modes, and up to 1Mbps in RS-232 mode. All drivers can be slew limited to 250kbps in any mode to minimize electromagnetic interference (EMI) by setting the dedicated SLEW pin low.

All transmitter outputs and receiver inputs feature robust electrostatic discharge (ESD) protection to ±15kV IEC 61000-4-2 Airgap, ±15kV Human Body Model (HBM) and ±8kV IEC 61000-4-2 Contact. Each receiver output has full fail-safe protection to avoid system lockup, oscillation, or indeterminate states by defaulting to logic-high output level when the inputs are open, shorted, or terminated but undriven. No external biasing resistors are required.

The RS-232 receiver inputs include a $5 \mathrm{k}\Omega$ pull-down to ground when in RS-232 mode. The RS-485/422 receiver inputs are high impedance (>96 $\mathrm{k}\Omega$), allowing up to 256 devices on a single communication bus (1/8th unit load).

The XR3160 operates from a single power supply, 3V to 5.5V, with low idle current. The shutdown mode consumes less than $1\mu A$ in low power standby operation with RS-232 receivers enabled.

FEATURES

- Pin Compatible Upgrade for MAX3160 (20 SSOP)
- IEC Level 4 ESD Protection
 - ±15kV IEC 61000-4-2 Air Gap Discharge
 - ± 8kV IEC 61000-4-2 Contact Discharge
 - ±15kV Human Body Model (HBM)
- 20Mbps RS-485 and 1Mbps RS-232 Data Rates
- Pin-Selectable 250kbps Slew Limiting
- Single Supply Operation from +3V to +5.5V
- 2 Drivers, 2 Receivers RS-232/V.28
- 1 Driver, 1 Receiver RS-485/422
 - Full or Half Duplex Configuration
 - 1/8th Unit Load, up to 256 receivers on bus
- RS-485/422 Enhanced Receiver Fail-safe for open, shorted, or terminated but idle inputs
- 10nA Shutdown Supply Current (typical)

TYPICAL APPLICATIONS

- Software Programmable Serial Ports (RS-232, RS-422, RS-485)
- Embedded and Industrial PCs (IPC)
- Process Control Equipment
- Point-Of-Sales Equipment
- Networking Equipment
- HVAC Controls Equipment
- Building Security and Automation

ORDERING INFORMATION(1)

PART NUMBER	OPERATING TEMPERATURE RANGE	LEAD-FREE	PACKAGE	PACKAGING METHOD
XR3160EIU-F	-40°C to +85°C			Tube
XR3160EIUTR-F	-40 0 10 100 0	Yes ⁽²⁾	20-pin SSOP	Tape and Reel
XR3160ECU-F	0°C to +70°C	res' /	20-piii 000i	Tube
XR3160ECUTR-F	0 0 10 170 0			Tape and Reel

Note:

- 1. Refer to www.exar.com/XR3160 for most up-to-date Ordering Information.
- 2. Visit www.exar.com for additional information on Environmental Rating.



ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections to the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability and cause permanent damage to the device.

Supply Voltage V _{CC}	-0.3V to +6.0V
Voltage at TTL Input Pins	-0.3V to +6.0V
Receiver Input Voltage (from Ground)	±18V
Driver Output Voltage (from Ground)	±18V
Short Circuit Duration, TX out to Ground	Continuous
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Power Dissipation 20-pin SSOP (derate 12.0mW/°C above +70°C)	662mW
ESD Ratings	
HBM - Human Body Model (Tx Output & Rx Input pins)	±15kV
HBM - Human Body Model (all other pins)	±3kV
IEC 61000-4-2 Airgap Discharge (Tx Output & Rx Input pins)	±15kV
IEC 61000-4-2 Contact Discharge (Tx Output & Rx Input pins)	±8kV

CAUTION:

ESD (ElectroStatic Discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Personnel should be properly grounded prior to handling this device. The protective foam should be discharged to the destination socket before devices are removed.



ELECTRICAL CHARACTERISTICS

UNLESS OTHERWISE NOTED:

SYMBOL	PARAMETERS	Min.	TYP.	Max.	Units	Conditions			
DC CHARAC	DC CHARACTERISTICS								
I _{CC}	Supply Current (RS-232)		1.2	2.5	mA	No load, Idle inputs, RS-485/RS-232 = 0V			
I _{CC}	Supply Current (RS-485/422)		2.5	5.5	mA	No load, Idle inputs, RS-485/RS-232 = V _{CC}			
I _{CC}	V _{CC} Shutdown Current		0.01	1	μΑ	SHDN = 0V, Receiver inputs open or grounded			
TRANSMITTE	TRANSMITTER and LOGIC INPUT PINS (DI, T1IN, T2IN, DE, SHDN, SLEW, HALF/FULL, RS-485/RS-232)								
V _{IL}	Logic Input Voltage Low			8.0	V				
V _{IH}	Logic Input Voltage High	2.0			V	V _{CC} = +3.3V			
V _{IH}	Logic Input Voltage High	2.4			V	V _{CC} = +5.0V			
I _{INL}	Logic Input Leakage Current		±0.01	±1	μA				
V _{HYS}	Logic Input Hysteresis		0.2		V				
RS-232 and F	RS-485/422 RECEIVER OUTPUTS (R10	OUT, R20	OUT, RO)					
V _{OL}	Receiver Output Voltage Low			0.4	V	I _{OUT} = 2.5mA			
V _{OH}	Receiver Output Voltage High	V _{CC} -0.6			V	I _{OUT} = -1.5mA			
I _{oss}	Receiver Output Short Circuit Current		±20	±85	mA	$0 \le V_O \le V_{CC}$			
l _{oz}	Receiver Output Leakage Current		±0.05	±1	μA	$0 \le V_O \le V_{CC}$, Receivers disabled			



ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:

SYMBOL	PARAMETERS	Min.	TYP.	Max.	Units	CONDITIONS		
RS-232 SINGLE-ENDED RECEIVER INPUTS (R1IN, R2IN)								
V _{IN}	Input Voltage Range	-15		+15	V			
V _{IL}	Input Threshold Low	0.6	1.2		V	V _{CC} = +3.3V		
۷IL	Input Theshold Low	0.8	1.5		V	V _{CC} = +5.0V		
V _{IH}	Input Throshold High		1.5	2.0	V	V _{CC} = +3.3V		
VIН	Input Threshold High		1.8	2.4	V	V _{CC} = +5.0V		
V _{HYS}	Input Hysteresis		0.5		V			
R _{IN}	Input Resistance	3	5	7	kΩ	$V_{CC} = +3.0V \text{ to } 5.5V$		
RS-232 SINC	GLE-ENDED TRANSMITTER OUTPUT	S (T10U1	, T2OUT)				
V _{OUT}	Output Voltage Swing	±5.0	±5.4		V	Outputs loaded with $3 \text{k}\Omega$ to Gnd		
R _{OFF}	Output Power Off Impedance	300	10M		Ω	$V_{CC} = 0V$, $V_{OUT} = \pm 2V$		
I _{SC}	Output Short Circuit Current		±30	±60	mA	V _{OUT} = 0V		
I _O	Output Leakage Current			±125	μA	SHDN = 0V, V _{OUT} = ±9V, V _{CC} = 0V or 5.5V		



ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:

SYMBOL	PARAMETERS	MIN.	TYP.	Max.	Units	Conditions
RS-485/422	DIFFERENTIAL RECEIVER INPUTS (A,	В)				
R _{IN}	Receiver Input Resistance	96			kΩ	$-7V \le V_{CM} \le +12V$
I _{IN}	Receiver Input Current			125	μA	V _{IN} = +12V
'IN	Receiver input Guirent			-100	μA	V _{IN} = -7V
V _{TH}	Receiver Differential Threshold Voltage	-200	-125	-50	mV	-7V ≤ V _{CM} ≤ +12V
ΔV_{TH}	Receiver Input Hysteresis		30		mV	
RS-485/422	DIFFERENTIAL DRIVER OUTPUTS (Y,	Z) 1.5		V _{CC}	V	$R_L = 54\Omega$ (RS-485), Figure 4
						_ , , ,
V _{OD}	Differential Driver Output	1.5		V _{CC}	V	-7V ≤ V _{CM} ≤ +12V, Figure 5
		2		V _{CC}	V	$R_L = 100\Omega$ (RS-422), Figure 4
$ \Delta V_{OD} $	Change In Magnitude of Differential Output Voltage			0.2	٧	R_L = 54Ω or 100Ω, Figure 4
V _{CM}	Driver Common Mode Output Voltage			3	V	R_L = 54Ω or 100Ω, Figure 4
ΔV _{CM}	Change In Magnitude of Common Mode Output Voltage			0.2	٧	$R_L = 54\Omega$ or 100Ω , Figure 4
I _{OSD}	Driver Output Short Circuit Current			±250	mA	$-7V \le V_Y$ or $V_Z \le +12V$, Figure 6
I _O	Driver Output Leakage Current			±125	μА	DE = 0V or \overline{SHDN} = 0V, V _Y or V _Z = -7V or +12V, V _{CC} = 0V or 5.25V



TIMING CHARACTERISTICS

UNLESS OTHERWISE NOTED:

SYMBOL	PARAMETERS	Min.	TYP.	Max.	Units	Conditions
ALL MODES						
t _{ENABLE}	Enable from Shutdown		1000		ns	
t _{SHUTDOWN}	Enable to Shutdown		1000		ns	
RS-232, DAT	A RATE = 250kbps (SLEW = 0V), ONE	TRANSI	MITTER	SWITCH	ING	
	Maximum Data Rate	250			kbps	$R_L = 3k\Omega, C_L = 1000pF$
t _{RHL} , t _{RLH}	Receiver Propagation Delay		100		ns	C _I = 150pF, Figure 7
t _{RHL} -t _{RLH}	Receiver Propagation Delay Skew			100	ns	OL - 190pi , riguie 7
t _{DHL} , t _{DLH}	Driver Propagation Delay		1400		ns	$R_L = 3k\Omega, C_L = 2500pF,$
t _{DHL} -t _{DLH}	Driver Propagation Delay Skew			600	ns	Figure 8
		•			•	
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	6		30	V/µs	V_{CC} = +3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 2500pF, T_A = 25°C, Figure 8
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	4		30	V/µs	V_{CC} = +3.3V, R_L = 3kΩ to 7kΩ, C_L = 150pF to 2500pF, Figure 8
RS-232, DAT	A RATE = 1Mbps (SLEW = V _{CC}), ONE	TRANSI	IITTER S	SWITCH	ING	
	Maximum Data Rate	1			Mbps	$R_L = 3k\Omega$, $C_L = 250pF$
t _{RHL} , t _{RLH}	Receiver Propagation Delay		100		ns	C _I = 150pF, Figure 7
t _{RHL} -t _{RLH}	Receiver Propagation Delay Skew			100	ns	OL - 130pr, Figure 7
t _{DHL} , t _{DLH}	Driver Propagation Delay		300		ns	$R_L = 3k\Omega, C_L = 1000pF,$
t _{DHL} -t _{DLH}	Driver Propagation Delay Skew			150	ns	Figure 8
		•			•	
^t shl, ^t slh	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	13		150	V/µs	V_{CC} = +3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 1000pF, Figure 8
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	24		150	V/µs	V_{CC} = +3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 1000pF, T_A = 25°C, Figure 8



TIMING CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:

SYMBOL	PARAMETERS	Min.	TYP.	Max.	Units	Conditions
RS-485/RS-42	2, DATA RATE = 250kbps (SLEW = 0	V), ONE T	RANSM	ITTER S	wiтсні	NG
	Maximum Data Rate	250			kbps	$R_L = 54\Omega, C_L = 50pF$
t _{RPHL} , t _{RPLH}	Receiver Propagation Delay		50	150	ns	C _L = 15pF, Figure 9
t _{RPHL} -t _{RPLH}	Receiver Propagation Delay Skew			10	ns	OL - 10pi , i iguie 9
t _{DPHL} , t _{DPLH}	Driver Propagation Delay		500	1000	ns	
t _{DPHL} -t _{DPLH}	Driver Propagation Delay Skew			100	ns	$R_L = 54\Omega$, $C_L = 50pF$, Figure 10
$t_{DR,} t_{DF}$	Driver Rise and Fall Time	300	650	1200	ns	Tigalo To
-	'			ı	ı	
t _{DZH} , t _{DZL}	Driver Output Enable Time			1000	ns	$R_L = 500\Omega, C_L = 50pF,$
t _{DHZ} , t _{DLZ}	Driver Output Disable Time			200	ns	Figure 11
RS-485/RS-42	2, DATA RATE = 20Mbps (SLEW = V	_{CC}), ONE	TRANSM	NITTER S		
	Maximum Data Rate	20			I Mhnc	D = 540 C = 50°C
t _{RPHL} , t _{RPLH}		+		1=0	Mbps	$R_L = 54\Omega$, $C_L = 50pF$
	Receiver Propagation Delay		50	150	Mbps ns	$R_L = 54\Omega$, $C_L = 50pF$ $C_L = 15pF$, Figure 9
t _{RPHL} -t _{RPLH}	Receiver Propagation Delay Receiver Propagation Delay Skew		50	150 10		
$ t_{RPHL}-t_{RPLH} $ t_{DPHL}, t_{DPLH}			50		ns	C _L = 15pF, Figure 9
	Receiver Propagation Delay Skew			10	ns ns	C_L = 15pF, Figure 9 R_L = 54 Ω , C_L = 50pF,
t _{DPHL} , t _{DPLH}	Receiver Propagation Delay Skew Driver Propagation Delay			10	ns ns	C _L = 15pF, Figure 9
t _{DPHL} , t _{DPLH}	Receiver Propagation Delay Skew Driver Propagation Delay Driver Propagation Delay Skew		30	10 100 10	ns ns ns	C_L = 15pF, Figure 9 R_L = 54 Ω , C_L = 50pF,
t _{DPHL} , t _{DPLH}	Receiver Propagation Delay Skew Driver Propagation Delay Driver Propagation Delay Skew		30	10 100 10	ns ns ns	C_L = 15pF, Figure 9 R_L = 54 Ω , C_L = 50pF,



PIN DESCRIPTIONS

Pin	Name	RS-232	RS-485 Full Duplex	RS-485 Half Duplex			
1	C1+	Charge pump cap 1 positive lead, 0.1µF					
2	VCC	Main Supply, V_{CC} = +3.0V to +5.5V, bypass to ground with 1.0 μ F					
3	C1-	С	harge pump cap 1 negative lea	ad			
4	GND		Ground				
5	T1OUT, B/Z	Transmitter 1 Output	Z Driver Neg Output	B/Z Neg Input/Output			
6	T2OUT, A/Y	Transmitter 2 Output	Y Driver Pos Output	A/Y Pos Input/Output			
7	R10UT	Receiver 1 Output	Х	X			
8	R2OUT, RO	Receiver 2 Output	Receiver TTL Output	Receiver TTL Output			
9	SHDN	Lov	v power shutdown mode when	low			
10	SLEW	Data	a rate limited to 250kbps when	low			
11	RS-485/RS-232	0	1	1			
12	HALF/FULL	Х	0	1			
13	R2IN, A	Receiver 2 Input	A Pos Receiver Input	X			
14	R1IN, B	Receiver 1 Input	B Neg Receiver Input	X			
15	T2IN, DE	Transmitter 2 Input	Driver enable	ed when high			
16	T1IN, DI	Transmitter 1 Input	Transmitter 1 Input Driver TTL Input				
17	V-	Charge p	ump negative supply, 0.1µF fro	om ground			
18	C2-	С	harge pump cap 2 negative lea	ad			
19	C2+	Char	ge pump cap 2 positive lead, 0).1µF			
20	V+	Charge	pump positive supply, 0.1µF to	ground			



SUGGESTED DB9 CONNECTOR PINOUT

DB9 Pin	RS-232	RS-485 Full Duplex	RS-485 Half Duplex
1			
2	RXD	RX+	
3	TXD	TX-	Data-
4			
5		Ground	
6			
7	RTS	TX+	Data+
8	CTS	RX-	
9			



BLOCK DIAGRAMS

FIGURE 1. RS-232 MODE

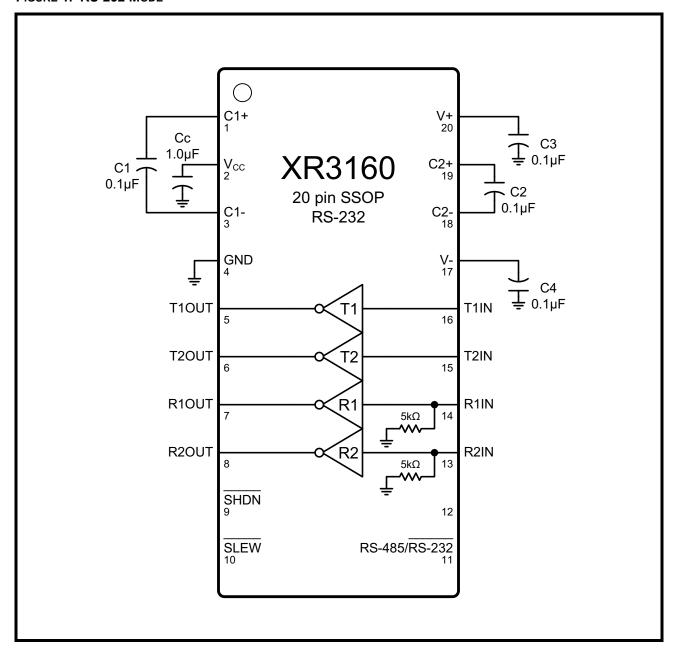




FIGURE 2. RS-485/422 FULL DUPLEX MODE

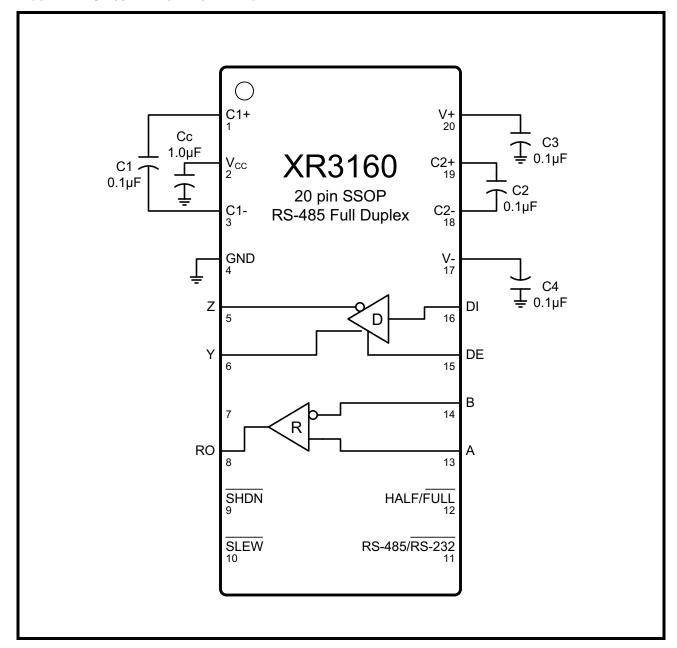
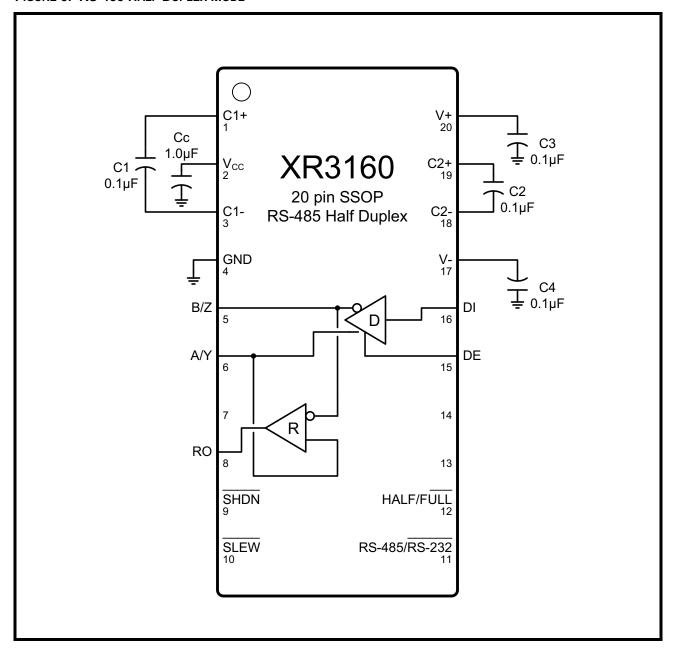




FIGURE 3. RS-485 HALF DUPLEX MODE





TEST CIRCUITS

FIGURE 4. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE

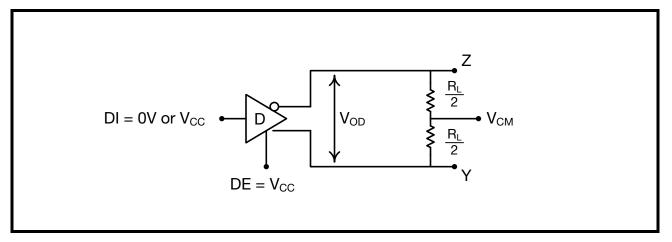


FIGURE 5. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE OVER COMMON MODE

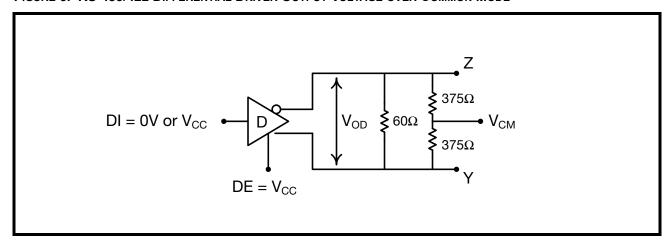


FIGURE 6. RS-485/422 DRIVER OUTPUT SHORT CIRCUIT CURRENT

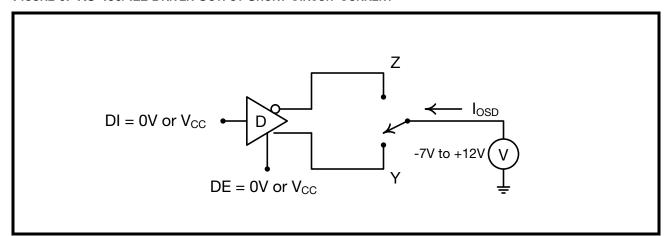




FIGURE 7. RS-232 RECEIVER PROPAGATION DELAY

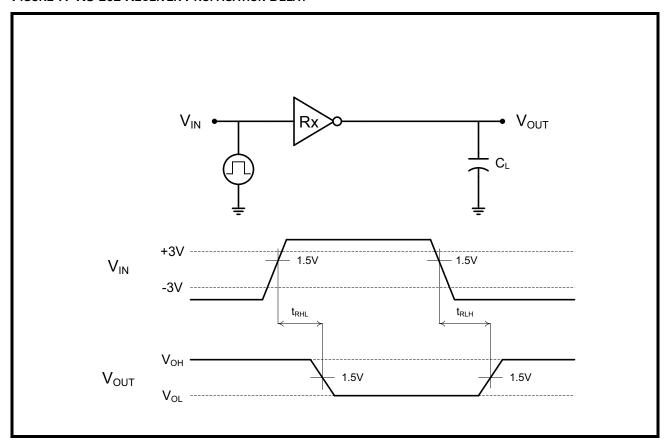




FIGURE 8. RS-232 DRIVER PROPAGATION DELAY

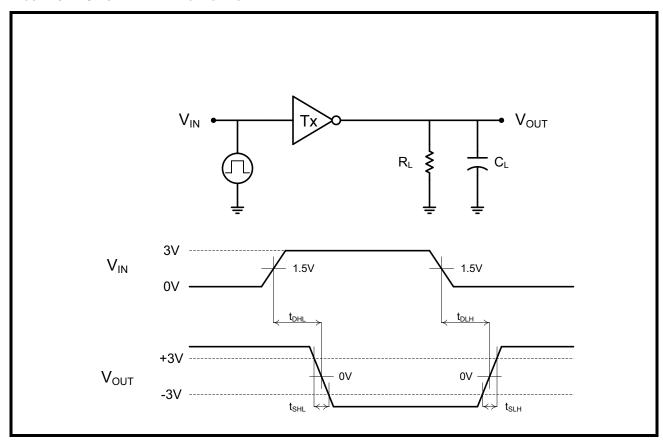




FIGURE 9. RS-485/422 RECEIVER PROPAGATION DELAY

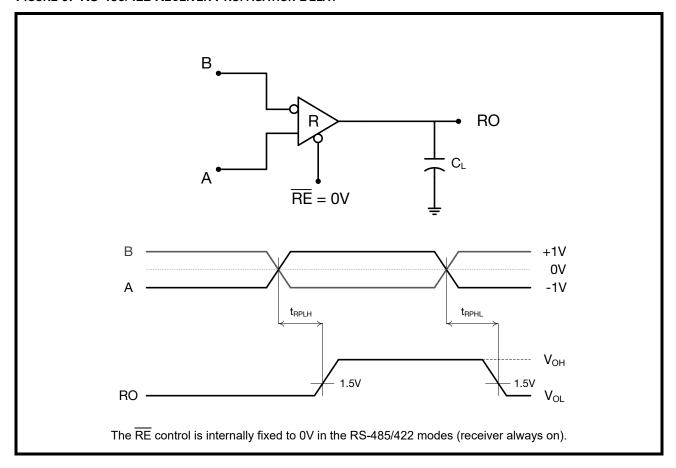




FIGURE 10. RS-485/422 DRIVER PROPAGATION DELAY AND RISE/FALL TIMES

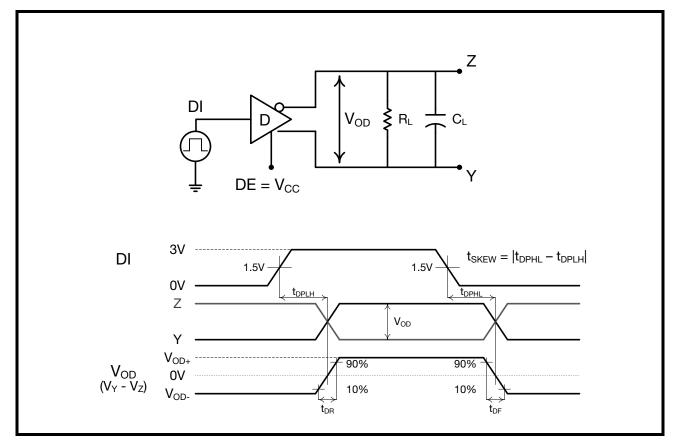
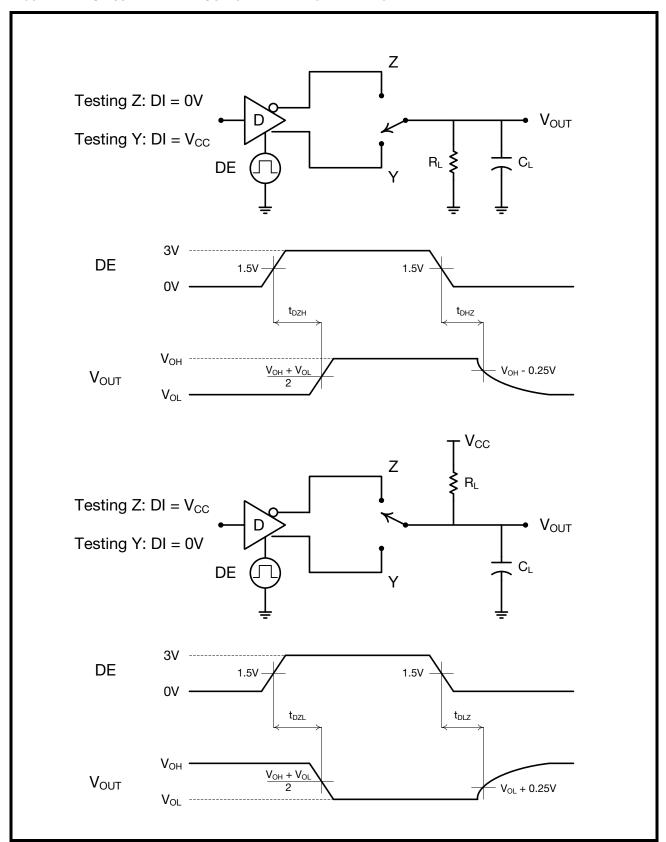




FIGURE 11. RS-485/422 DRIVER OUTPUT ENABLE/DISABLE TIMES





PRODUCT SUMMARY

The XR3160 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards. Full operation requires only four external charge pump capacitors.

ENHANCED FAILSAFE

The enhanced failsafe feature of the XR3160 guarantees a logic-high receiver output when the receiver inputs are open, shorted, or terminated but idle/undriven. The enhanced failsafe interprets 0V differential as a logic high with a minimum 50mV noise margin, while maintaining compliance with the EIA/TIA-485 standard of ±200mV. No external biasing resistors are required, further easing the usage of multiple protocols over a single connector.

±15kV ESD PROTECTION

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The bus pins (driver outputs and receiver inputs) have extra protection structures, which have been tested up to ±15kV without damage. These structures withstand high ESD in all states: normal operation, in shutdown, and when powered off.

ESD protection is be tested in various ways. MaxLinear uses the following methods to qualify the protection structures designed into XR3160:

±8kV using IEC 61000-4-2 Contact Discharge

±15kV using IEC 61000-4-2 Airgap Discharge

±15kV using the Human Body Model (HBM)

The IEC 61000-4-2 standard is more rigorous than HBM, resulting in lower voltage levels compared with HBM for the same level of ESD protection. Because IEC 61000-4-2 specifies a lower series resistance, the peak current is higher than HBM. The XR3160 has passed both HBM and IEC 61000-4-2 testing without damage.



TRUTH TABLES

TABLE 1: RS-232 TX TRUTH TABLE

	INPUTS				
SHDN	RS-485/RS-232	DI/T1IN, DE/T2IN	Z(B)/T1OUT, Y(A)/T2OUT		
0	X	X	1/8th unit load		
1	0	0	1		
1	0	1	0		
1	1	X	RS-485 Mode		

TABLE 2: RS-232 RX TRUTH TABLE

	OUTPUTS		
SHDN	RS-485/RS-232	B/R1IN, A/R2IN	R10UT, RO/R20UT
Х	0	0	1
Х	0	1	0
Х	0	Inputs open	1
×	1	×	R1OUT High-Z, RO/R2OUT in RS-485 Mode



TABLE 3: RS-485/422 TX TRUTH TABLE

	INPUTS				PUTS
SHDN	RS-485/RS-232	DE/T2IN	DI/T1IN	Z(B)/T1OUT	Y(A)/T2OUT
0	Х	Х	Х	1/8th unit load	1/8th unit load
1	1	0	Х	1/8th unit load	1/8th unit load
1	1	1	0	1	0
1	1	1	1	0	1
Х	0	Х	Х	RS-232	2 Mode

TABLE 4: RS-485/422 RX TRUTH TABLE

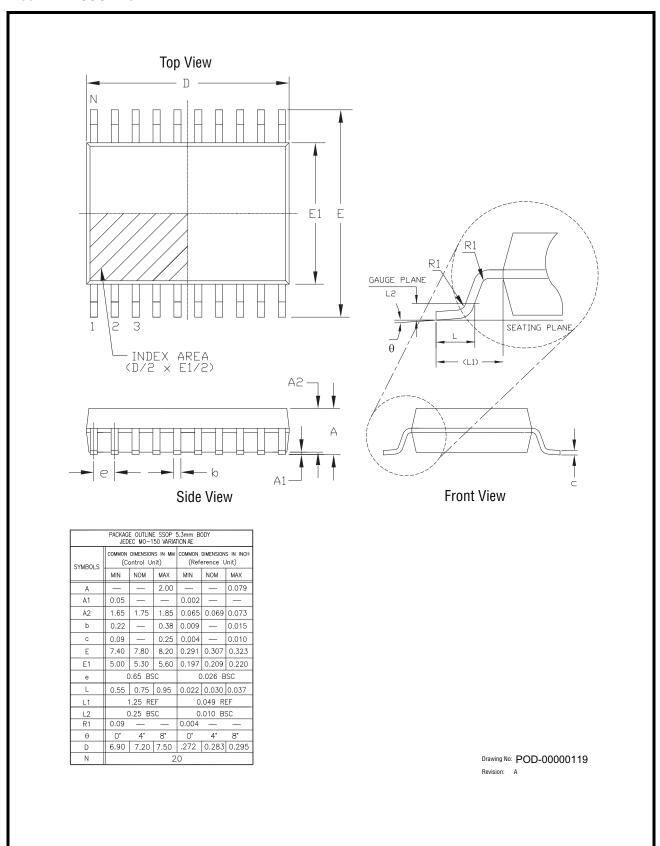
	INPUTS				
RS-485/RS-232	SHDN	HALF/FULL	(A-B)	(Y-Z)	RO/R2OUT
1	0	Х	Х	Х	High-Z
1	1	0	≥ -50mV	Х	1
1	1	0	≤ - 200mV	Х	0
1	1	0	Floating	Х	1
1	1	1	Х	≥ -50mV	1
1	1	1	Х	≤ -200mV	0
1	1	1	Х	Floating	1
0	Х	Х	Х	Х	RS-232 Mode

^{*} Y and Z correspond to pins 6 and 5. A and B correspond to pins 13 and 14.



MECHANICAL DIMENSIONS

FIGURE 12. SSOP 20





REVISION HISTORY

DATE	REVISION	DESCRIPTION	
Sept 2013	1.0.0	Production Release	
Jan 2018	1.0.1	Update to MaxLinear logo. Update format and Ordering Information. Moved ESD ings on page 2.	



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